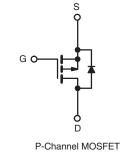
Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	- 60			
R _{DS(on)} (Ω)	V _{GS} = - 10 V 0.28			
Q _g (Max.) (nC)	19			
Q _{gs} (nC)	5.4			
Q _{gd} (nC)	11			
Configuration	Single			





FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- For Automatic Insertion
- End Stackable
- P-Channel
- Fast Switching
- 175 °C Operating Temperature
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain servers as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION	
Package	HVMDIP
Load (Pb) free	IRFD9024PbF
Lead (Pb)-free	SiHFD9024-E3
SnPb	IRFD9024
	SiHFD9024

ABSOLUTE MAXIMUM RATINGS (TA	= 25 °C, unless otherwis	se noted)			
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	- 60	v	
Gate-Source Voltage		V _{GS}	± 20	v	
Continuous Drain Current	$V_{GS} \text{ at } -10 \text{ V} \frac{T_A = 25 \text{ °C}}{T_A = 100 \text{ °C}}$	1	- 1.6		
Continuous Drain Current	V_{GS} at - 10 V $T_A = 100 \text{ °C}$	I _D	- 1.1	А	
Pulsed Drain Current ^a	I _{DM}	- 13	1		
Linear Derating Factor		0.0083	W/°C		
Single Pulse Avalanche Energy ^b		E _{AS}	140	mJ	
Avalanche Current ^a		I _{AR}	- 1.6	Α	
Repetitive Avalanche Energy ^a		E _{AR}	0.13	mJ	
Maximum Power Dissipation	T _A = 25 °C	PD	1.3	W	
Peak Diode Recovery dV/dtc	dV/dt	- 4.5	V/ns		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 175	°C	
Soldering Recommendations (Peak Temperature) for 10 s			300 ^d		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

- b. V_{DD} = 25 V, starting T_J = 25 °C, L = 15 mH, R_g = 25 Ω , I_{AS} = 3.2 A (see fig. 12).
- c. $I_{SD} \leq$ 11 A, dl/dt \leq 140 A/µs, $V_{DD} \leq V_{DS}, \, T_J \leq$ 175 °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP		MAX.			UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-		120			°C/W	
SPECIFICATIONS ($T_J = 25 \text{ °C}$, u	inless otherw	ise noted)			0	1	0	
PARAMETER	SYMBOL	TES	T CONDITI	ONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	0 V, $I_D = -2$	250 µA	- 60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I	_D = - 1 mA	-	- 0.056	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} =$	V_{GS} , $I_D = -2$	250 μΑ	- 2.0	-	- 4.0	V
Gate-Source Leakage	I _{GSS}	, v	V _{GS} = ± 20 '	V	-	-	± 100	nA
Zara Cata Valtaga Drain Current		V _{DS} =	- 60 V, V _{GS}	_s = 0 V	-	-	- 100	
Zero Gate Voltage Drain Current	IDSS	V _{DS} = - 48 V, V _{GS} = 0 V, T _J = 150 °C		-	-	- 500	μA	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = - 10 V	I _D =	- 0.96 A ^b	-	-	0.28	Ω
Forward Transconductance	9 _{fs}	V _{DS} = -	25 V, I _D = -	0.96 A ^b	1.3	-	-	S
Dynamic		•				•		
Input Capacitance	C _{iss}		V _{GS} = 0 V		-	570	-	
Output Capacitance	Coss		V _{DS} = - 25 V	V	-	360	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1.	0 MHz, see	fig. 5	-	65	-	
Total Gate Charge	Qg				-	-	19	
Gate-Source Charge	Q _{gs}	V _{GS} = - 10 V		A, V _{DS} = - 48 V g. 6 and 13 ^b	-	-	5.4	nC
Gate-Drain Charge	Q _{gd}		000 11		-	-	11	
Turn-On Delay Time	t _{d(on)}		•		-	13	-	
Rise Time	t _r	Vaa -	- 30 V In -	- 11 Δ	-	68	-	
Turn-Off Delay Time	t _{d(off)}	$R_g = 18 \Omega,$	V_{DD} = - 30 V, I_D = - 11 A R _g = 18 Ω , R _D = 2.5 Ω , see fig. 10 ^b		-	15	-	ns
Fall Time	t _f				-	29	-	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.0	-		
Internal Source Inductance	L _S			-	6.0	-	nH	
Drain-Source Body Diode Characteristic	cs							
Continuous Source-Drain Diode Current	I _S	MOSFET sym			-	-	- 1.6	•
Pulsed Diode Forward Current ^a	I _{SM}	integral revers p - n junction			-	-	- 13	A
Body Diode Voltage	V _{SD}	T _J = 25 °C,	I _S = - 1.6 A	, $V_{GS} = 0 V^{b}$	-	-	- 6.3	V
Body Diode Reverse Recovery Time	t _{rr}			/dt _ 100 ^ /	-	100	200	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$I_{\rm J} = 25^{-1}$, $I_{\rm F} =$	= - 11 A, dl/	/dt = 100 A/µs ^b	-	0.32	0.64	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time i	is negligible (turn	-on is dor	minated b	y L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 $\mu s;$ duty cycle \leq 2 %





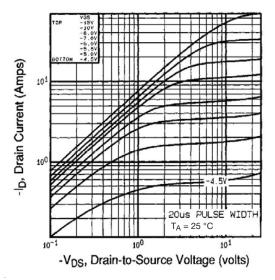


Fig. 1 - Typical Output Characteristics, $T_A = 25 \ ^{\circ}C$

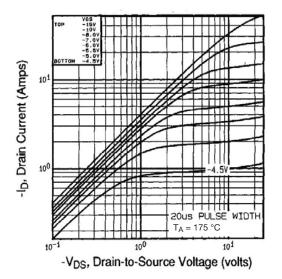


Fig. 2 - Typical Output Characteristics, T_A = 175 °C

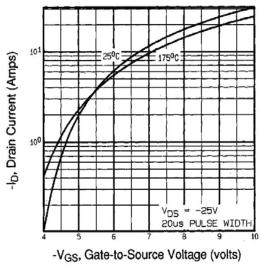


Fig. 3 - Typical Transfer Characteristics

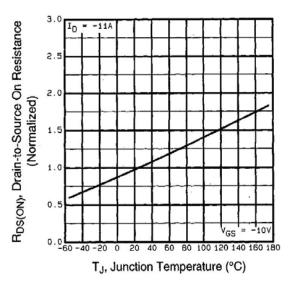


Fig. 4 - Normalized On-Resistance vs. Temperature



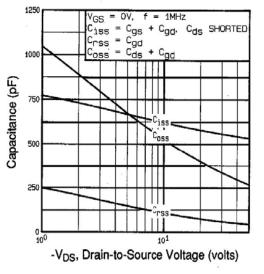


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

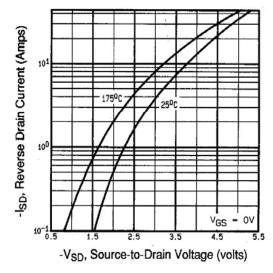


Fig. 7 - Typical Source-Drain Diode Forward Voltage

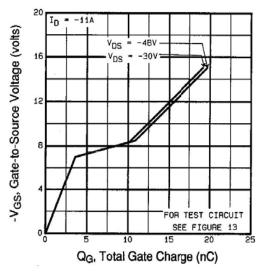


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

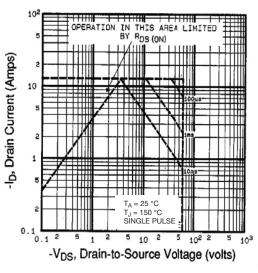


Fig. 8 - Maximum Safe Operating Area



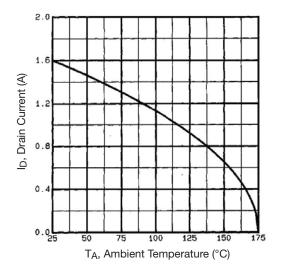


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

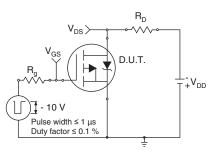


Fig. 10a - Switching Time Test Circuit

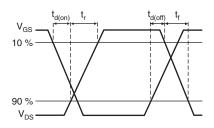


Fig. 10b - Switching Time Waveforms

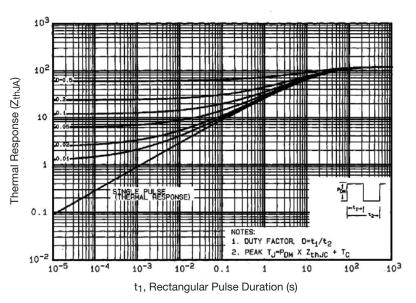


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



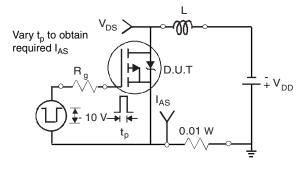


Fig. 12a - Unclamped Inductive Test Circuit

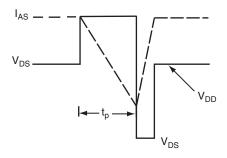


Fig. 12b - Unclamped Inductive Waveforms

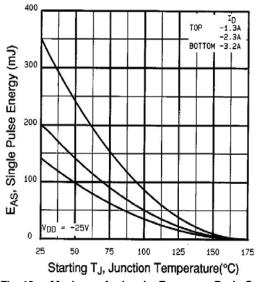
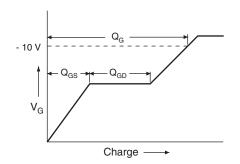


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





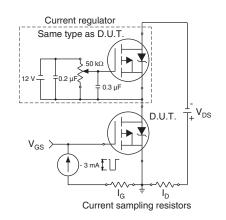
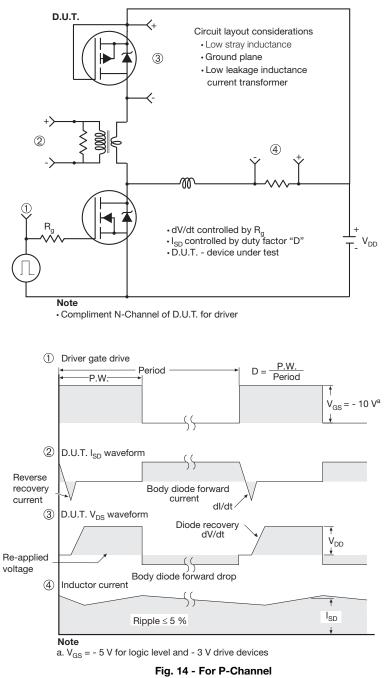


Fig. 13b - Gate Charge Test Circuit



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Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg291137.



HVM DIP (High voltage)





	INCHES		MILLIN	IETERS
DIM.	MIN.	MAX.	MIN.	MAX.
А	0.310	0.330	7.87	8.38
E	0.300	0.425	7.62	10.79
L	0.270	0.290	6.86	7.36
ECN: X10-0386-Rev. B, 0 DWG: 5974	06-Sep-10			

Note

1. Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.



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